

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Hideyo Nakamura	06/21/2013
RECEIVING PARTY DATA	
Name:	Fuji Electric Co., Ltd.
Street Address:	1-1 Tanabeshinden, Kawasaki-ku
City:	Kawasaki-shi, Kanagawa
State/Country:	JAPAN
Postal Code:	210-9530
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29458667
CORRESPONDENCE DATA	
Fax Number:	2486493338
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	248-649-3333
Email:	leighton@youngbasile.com
Correspondent Name:	Young Basile Hanlon & MacFarlane, P.C.
Address Line 1:	3301 West Big Beaver Rd
Address Line 2:	Suite 624
Address Line 4:	Troy, MICHIGAN 48084
ATTORNEY DOCKET NUMBER:	MOR-310-A
NAME OF SUBMITTER:	Michelle L. Knight
Signature:	/Michelle L. Knight/
Date:	06/28/2013
Total Attachments: 2 source=MOR310A_ExecutedAssign#page1.tif source=MOR310A_ExecutedAssign#page2.tif	

CH \$40.00 29458667

Our Reference:

ASSIGNMENT

WHEREAS, I

Hideyo NAKAMURA residing at

Matsumoto-shi NAGANO JAPAN,

have invented a

SEMICONDUCTOR MODULE

for which we are about to make application for Letters Patent of the United States of America; and

WHEREAS,

FUJI ELECTRIC CO., LTD.,

a corporation of **JAPAN** having its principal place of business at

**1-1, Tanabeshinden, Kawasaki-ku,
Kawasaki-shi, Kanagawa 210-9530 JAPAN**

desires to acquire the entire right, title and interest in and to said invention.

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable considerations, receipt whereof is hereby acknowledged, we, by these presents do sell, assign, and transfer unto said corporation, its successors and assigns, all right, title and interest in the United States of America and all foreign countries in and to said invention as described in the patent application executed by us on the 28th day of June, 2013, and we hereby authorize our attorneys, authorized to prosecute said application, to here insert the filing date and serial of said application, as soon as it is known, Serial No. 29/458,667, filed June 21, 2013, and to any improvements on said invention heretofore or hereafter made while we are in the employ of said corporation, and any divisions or continuations of said application, and all Patents, United States and foreign, granted upon any such applications or for the inventions described therein, and any reissues or extensions of said Patents; and we hereby authorize and request the Commissioner of Patents and Trademarks to issue all Patents on said United States applications to said corporation as assignee thereof.

FOR SAID CONSIDERATIONS, we hereby covenant and agree that we are the owners of the full title herein assigned and have the right to assign the same, and agree that we will communicate to said corporation or its representatives, any facts known to us respecting said invention or inventions and testify in any legal proceedings relating thereto when called upon, and will sign all instruments and documents and render such assistance which in the judgment of said corporation is necessary to vest in it and protect the legal title sought to be assigned.

Hideyo NAKAMURA

Hideyo Nakamura
Date: June 21, 2013